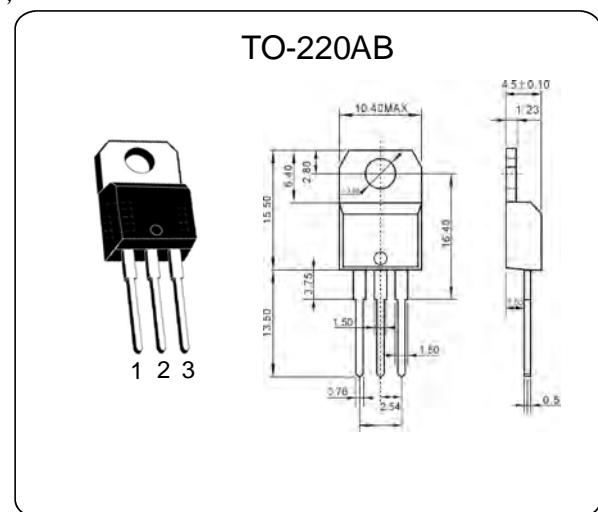


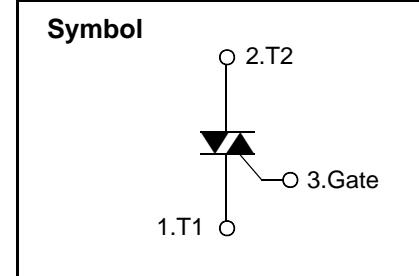
## **Bi-Directional Triode Thyristor**

- High current density due to double mesa technology, SIPOS and Glass passivation .
- BTA24 series triacs is suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits or phase control operation light dimmers, motorspeed controllers.
- BTA24 series are 3 Quadrants triacs, They are specially recommended for use on inductive loads.



## **Features**

- Blocking Voltage to 800 V
- On- State Current Rating of 20A RMS at 90 °C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt- 1500V/us minimum at 125 °C
- Minimizes Snubber Networks for Protection
- Industry Standard TO- 220AB Package
- High Commutating dI/dt- 4.0A/ms minimum at 125 °C
- Internally Isolated (2500VRMS)
- These are Pb- Free Devices



## **Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Storage junction temperature range	T <sub>stg</sub>	-40 to +150	°C
Operating junction temperature range	T <sub>j</sub>	-40 to + 125	°C
Repetitive Peak OFF-state Voltage	V <sub>DRM</sub>	800	V
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	800	V
Non repetitive surge peak off-state voltage	V <sub>DSM</sub>	900	V
Non repetitive peak reverse voltage	V <sub>RSM</sub>	900	V
RMS on-state current(full sine wave)	IT(RMS)	24	A
Non repetitive surge peak on-state current (full cycle,TJ=25 °C)	ITSM	250	A
I <sup>2</sup> t Value for fusing	I <sup>2</sup> t	340	A <sup>2</sup> s
Critical rate of rise of on-state current IG=2*IGT,tr≤100ns,f=120Hz,Tj=125 °C	dI/dt	50	A/us
Peak gate current(tp=20us,Tj=125 °C)	I <sub>GM</sub>	4	A
Peak gate power dissipation(tp=20us,Tj=125 °C)	P <sub>GM</sub>	10	W
Average gate power dissipation(Tj=125 °C)	PG(AV)	1	W

**Electrical Characteristics (T<sub>j</sub>=25 °C, unless otherwise specified)**

Symbol	Test Condition	Quadrant		Limit		Unit
				CW(C)	BW(B)	
I <sub>GT</sub>	V <sub>D</sub> =12V, R <sub>L</sub> =33Ω	I - II -III - IV	MAX	35	50	mA
V <sub>GT</sub>		I - II -III - IV	MAX	1.3		V
V <sub>GD</sub>	V <sub>D</sub> =V <sub>DRM</sub> R <sub>L</sub> =3.3KΩ T <sub>j</sub> =125°C	I - II -III - IV	MIN	0.2		V
I <sub>L</sub>	I <sub>G</sub> =1.2I <sub>GT</sub>	I - III - IV	MAX	50	70	mA
		II	MAX	60	80	mA
I <sub>H</sub>	I <sub>T</sub> =100mA		MAX	40	60	mA
Dv/dt	V <sub>D</sub> =67%V <sub>DRM</sub> gate open T <sub>J</sub> =125°C		MIN	500	1000	V/us
(Dv/dt) <sub>c</sub>	(dI/dt) <sub>c</sub> =8.8A/ms T <sub>j</sub> =125°C		MIN	8.5	14	V/us

**Static Characteristics**

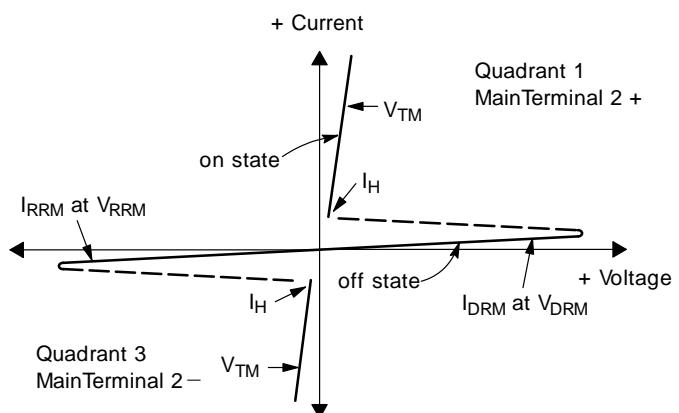
Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>TM</sub> =35A, tp=380us	T <sub>j</sub> =25°C	1.55	V
I <sub>DRM</sub>	V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub>	T <sub>j</sub> =25°C	5	uA
I <sub>RRM</sub>		T <sub>j</sub> =125°C	3	mA

**Thermal Resistances**

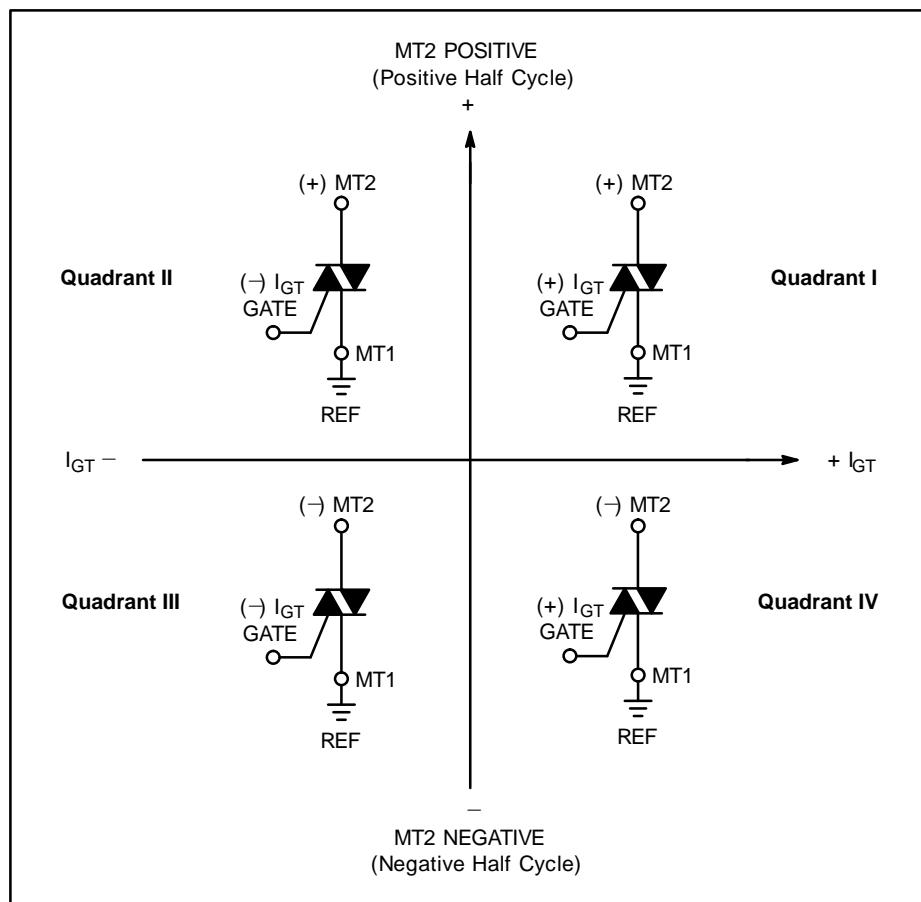
Symbol	Parameter	Value	Unit
R <sub>th</sub> (J-C)	Junction to case(AC)	1.7	°C/W

## Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
$V_{DRM}$	Peak Repetitive Forward Off State Voltage
$I_{DRM}$	Peak Forward Blocking Current
$V_{RRM}$	Peak Repetitive Reverse Off State Voltage
$I_{RRM}$	Peak Reverse Blocking Current
$V_{TM}$	Maximum On State Voltage
$I_H$	Holding Current

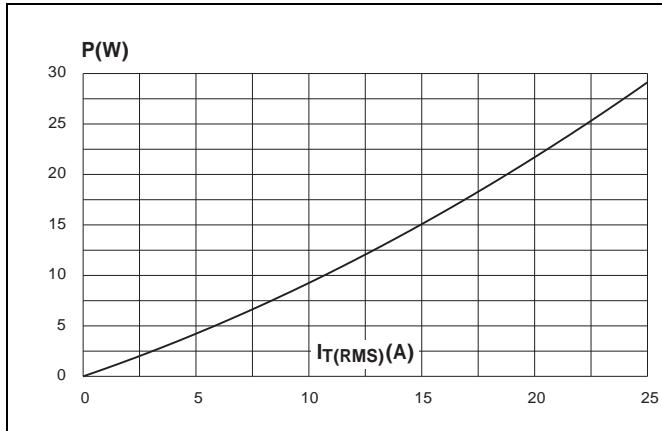


### Quadrant Definitions for a Triac

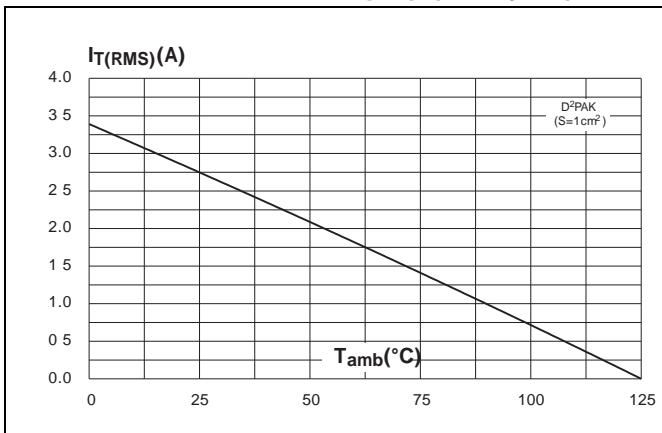


All polarities are referenced to MT1.  
With in-phase signals (using standard AC lines) quadrants I and III are used.

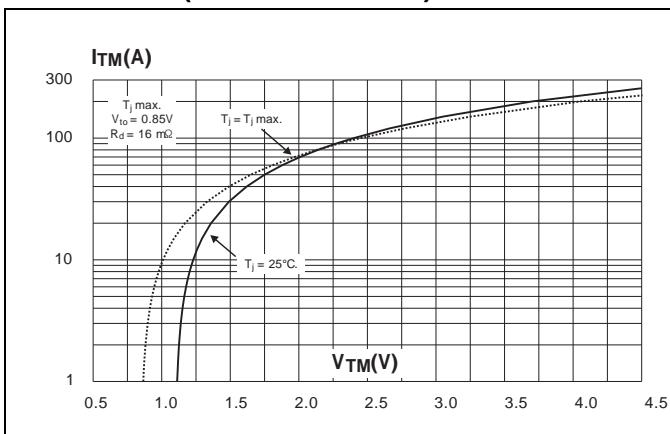
**Figure 1. Maximum power dissipation versus RMS on-state current (full cycle)**



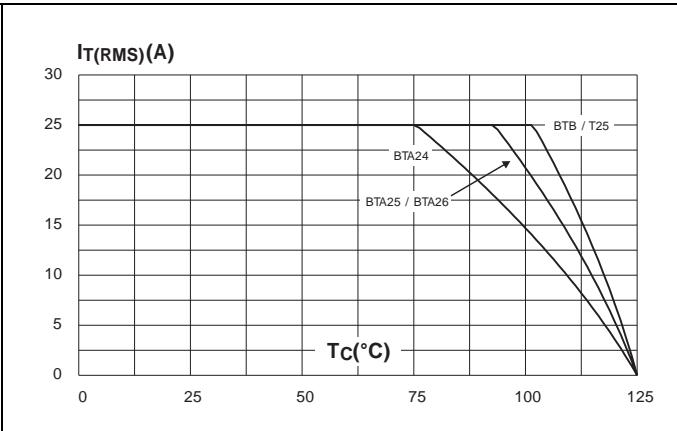
**Figure 3. D<sup>2</sup>PAK RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35µm) (full cycle)**



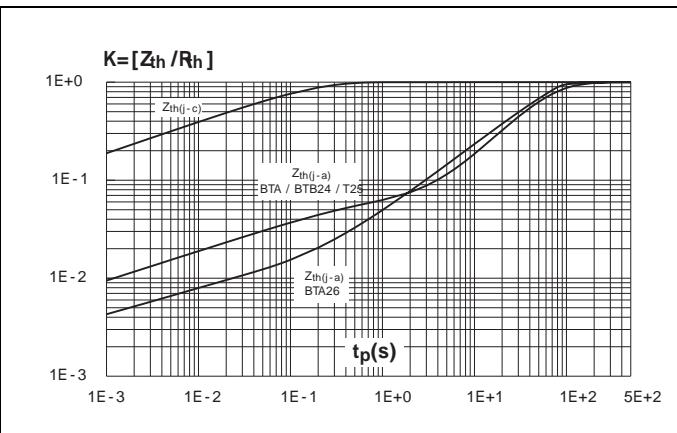
**Figure 5. On-state characteristics (maximum values)**



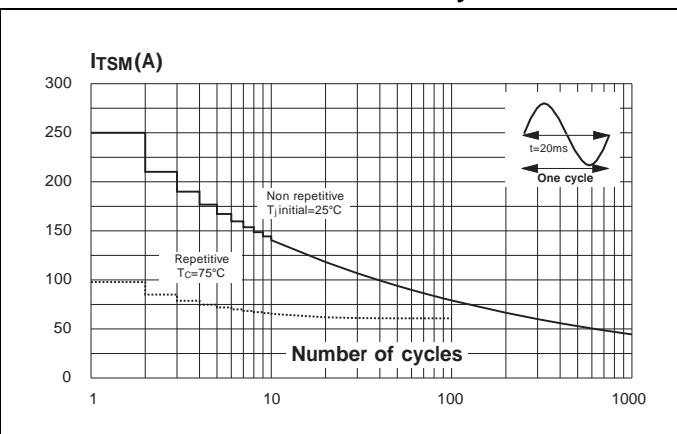
**Figure 2. RMS on-state current versus case temperature (full cycle)**



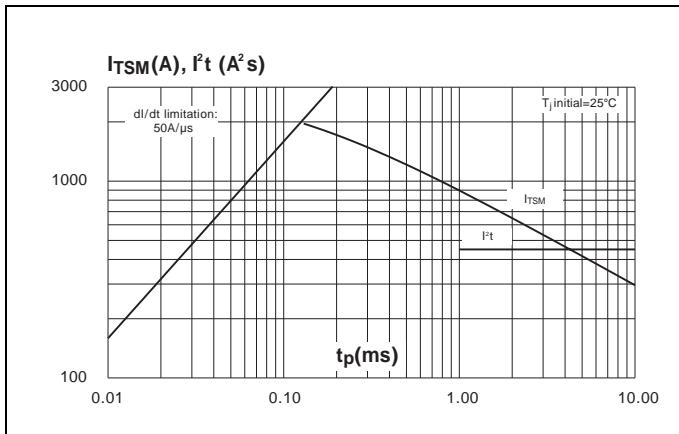
**Figure 4. Relative variation of thermal impedance versus pulse duration**



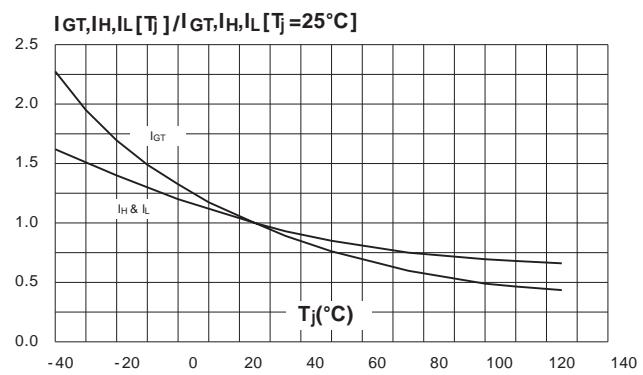
**Figure 6. Surge peak on-state current versus number of cycles**



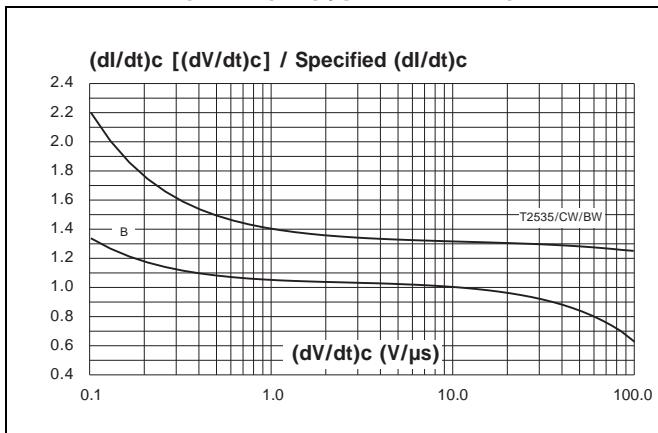
**Figure 7.** Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10$  ms and corresponding value of  $I^2t$



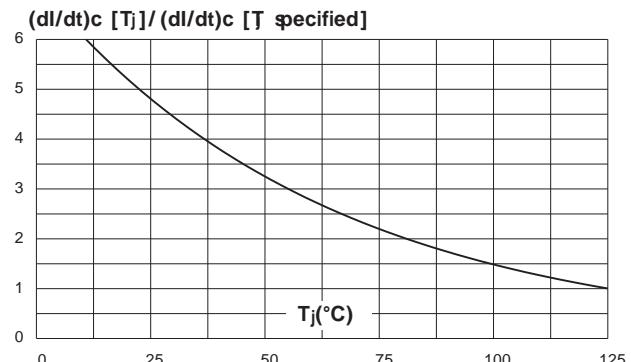
**Figure 8.** Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)



**Figure 9.** Relative variation of critical rate of decrease of main current versus  $(dV/dt)c$  (typical values)



**Figure 10.** Relative variation of critical rate of decrease of main current versus  $(dV/dt)c$  (typical values)



**Figure 11.** D<sup>2</sup>PAK Thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35  $\mu\text{m}$ )

